

TS4990

1W AUDIO POWER AMPLIFIER WITH ACTIVE LOW STANDBY MODE

ADVANCE DATA

\blacksquare OPERATING FROM $V_{cc} = 2.2V$ to 5.5V

■ 1W OUTPUT POWER @ Vcc=5V, THD=1%, f=1kHz, with 8Ω Load

- ULTRA LOW CONSUMPTION IN STANDBY MODE (10nA)
- 62dB PSRR @ 217Hz @ Grounded mode
- Zero POP & CLICK
- ULTRA LOW DISTORTION (0.1%)
- **UNITY GAIN STABLE**
- AVAILABLE IN 9 BUMPS Flip Chip Package

DESCRIPTION

The TS4990 has been designed for demanding audio applications such as mobile phones and to minimize the number of external components.

This Audio Power Amplifier is capable of delivering 1W of continuous RMS Ouput Power into an 8Ω load @ 5V.

An externally controlled standby mode control reduces the supply current to less than 10nA. It also includes an internal thermal shutdown protection.

The unity-gain stable amplifier can be configured by external gain setting resistors.

APPLICATIONS

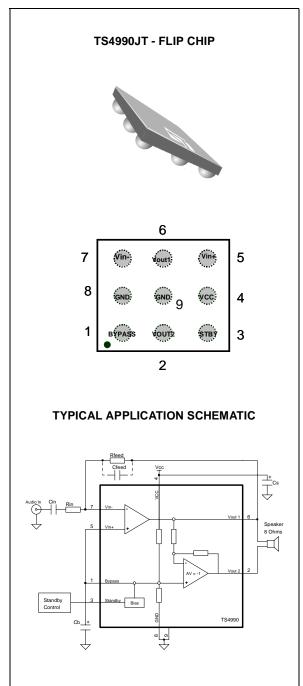
- Mobile Phones (Cellular / Cordless)
- Laptop / Notebook Computers
- PDAs
- Portable Audio Devices

ORDER CODE

Part Number	Temperature Range	Package		
Part Number		J		
TS4990IJT	-40, +85°C	•		

J = Flip Chip Package - only available in Tape & Reel (JT)

PIN CONNECTIONS (top view)



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ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V _{CC}	Supply voltage ¹⁾	6	
V _i	Input Voltage ²⁾	G _{ND} to V _{CC}	V
T _{oper}	Operating Free Air Temperature Range	-40 to + 85	°C
T _{stg}	Storage Temperature	-65 to +150	°C
T _j	Maximum Junction Temperature	150	°C
R _{thja}	Thermal Resistance Junction to Ambient ³⁾ Flip Chip	TBD	°C/W
Pd	Power Dissipation	Internally Limited	
ESD	Human Body Model	2	
ESD	Machine Model	200 \	
	Latch-up Immunity	Class A (200mA)	
	Lead Temperature (soldering, 10sec)	250	°C

OPERATING CONDITIONS

Symbol	Parameter	Value	Unit
V _{CC}	Supply Voltage	2.2 to 5.5	V
V _{ICM}	Common Mode Input Voltage Range	1.2V to V _{CC}	V
V _{STB}	Standby Voltage Input : Device ON Device OFF	$1.2 \le V_{STB} \le V_{CC}$ $GND \le V_{STB} \le 0.4$	٧
R _L	Load Resistor	4 - 32	Ω
R _{OUT}	Resistor Output to GND	> 1	МΩ
T _{SD}	Thermal Shutdown Temperature	150 min.	°C
R _{thja}	Thermal Resistance Junction to Ambient ¹⁾	TBD	°C/W

This thermal resistance can be reduced with a suitable PCB layout .

All voltages values are measured with respect to the ground pin.
 The magnitude of input signal must never exceed V_{CC} + 0.3V / G_{ND} - 0.3V
 Device is protected in case of over temperature by a thermal shutdown active @ 150°C.

ELECTRICAL CHARACTERISTICS

 $V_{CC} = +5V$, GND = 0V, $T_{amb} = 25$ °C (unless otherwise specified)

Symbol	Parameter	Min.	Тур.	Max.	Unit
I _{cc}	Supply Current No input signal, no load		4	6	mA
I _{STANDBY}	Standby Current $^{1)}$ No input signal, Vstdby = G_{ND} , RL = 8Ω		10	1000	nA
Voo	Output Offset Voltage No input signal, $RL = 8\Omega$		5	20	mV
Po	Output Power THD = 1% Max, f = 1kHz, RL = 8Ω	0.8	1		W
THD + N	Total Harmonic Distortion + Noise Po = 250mW rms, Gv = 2, 20Hz < f < 20kHz, RL = 8Ω		0.15		%
PSRR	Power Supply Rejection Ratio ²⁾ RL = 8Ω , Gv = 2, Vripple = 200mVpp, Input Grounded F = 217Hz F = 1kHz	55 55	62 66		dB
T_WU	Wake-Up Time		100	TBD	ms

^{1.} Standby mode is actived when Vstdby is tied to Gnd

 V_{CC} = **+3.3V**, GND = **0V**, T_{amb} = 25°C (unless otherwise specified)

Symbol	Parameter	Min.	Тур.	Max.	Unit
I _{cc}	Supply Current No input signal, no load		4	6	mA
I _{STANDBY}	Standby Current $^{1)}$ No input signal, Vstdby = G_{ND} , RL = 8Ω		10	1000	nA
Voo	Output Offset Voltage No input signal, $RL = 8\Omega$		5	20	mV
Po	Output Power THD = 1% Max, f = 1kHz, RL = 8Ω	380	450		mW
THD + N	Total Harmonic Distortion + Noise Po = 250mW rms, $Gv = 2$, $20Hz < f < 20kHz$, $RL = 8\Omega$		0.15		%
PSRR	Power Supply Rejection Ratio ²⁾ RL = 8Ω , Gv = 2, Vripple = 200mVpp, Input Grounded F = 217Hz F = 1kHz	55 55	62 66		dB
T _{WU}	Wake-Up Time		130	TBD	ms

^{1.} Standby mode is actived when Vstdby is tied to Vcc

 $^{2. \ \} Dynamic\ measurements-20*log(rms(Vout)/rms(Vripple)).\ Vripple\ is\ the\ surimposed\ sinus\ signal\ to\ Vcc.$

 $^{2. \ \ \, \}text{Dynamic measurements - 20*log(rms(Vout)/rms(Vripple))}. \ \, \text{Vripple is the surimposed sinus signal to Vcc.}$

ELECTRICAL CHARACTERISTICS

 $V_{CC} = 2.6V$, GND = 0V, $T_{amb} = 25$ °C (unless otherwise specified)

Symbol	Parameter	Min.	Тур.	Max.	Unit
I _{CC}	Supply Current No input signal, no load		4	6	mA
I _{STANDBY}	Standby Current $^{1)}$ No input signal, Vstdby = G_{ND} , RL = 8Ω		10	1000	nA
Voo	Output Offset Voltage No input signal, $RL = 8\Omega$		5	20	mV
Po	Output Power THD = 1% Max, f = 1kHz, RL = 8Ω	210	260		mW
THD + N	Total Harmonic Distortion + Noise Po = 200mW rms, Gv = 2, 20Hz < f < 20kHz, RL = 8Ω		0.15		%
PSRR	Power Supply Rejection Ratio ²⁾ RL = 8Ω , Gv = 2, Vripple = 200mVpp, Input Grounded F = 217Hz F = 1kHz	55 55	62 66		dB
T_WU	Wake-Up Time		130	TBD	ms

^{1.} Standby mode is actived when Vstdby is tied to Vcc

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Components	Functional Description		
Rin	Inverting input resistor which sets the closed loop gain in conjunction with Rfeed. This resistor also form a high pass filter with Cin (fc = 1 / (2 x Pi x Rin x Cin))		
Cin	Input coupling capacitor which blocks the DC voltage at the amplifier input terminal		
Rfeed	Feed back resistor which sets the closed loop gain in conjunction with Rin		
Cs	Supply Bypass capacitor which provides power supply filtering		
Cb	Bypass pin capacitor which provides half supply filtering		
Cfeed	Low pass filter capacitor allowing to cut the high frequency (low pass filter cut-off frequency 1 / (2 x Pi x Rfeed x Cfeed))		
Gv	Closed loop gain in BTL configuration = 2 x (Rfeed / Rin)		

REMARKS

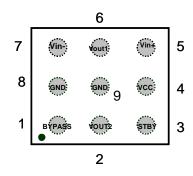
- **1.** All measurements, except PSRR measurements, are made with a supply bypass capacitor $Cs = 1\mu F$.
- **2.** The standby response time is about 1μ s.

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TS4990IJT

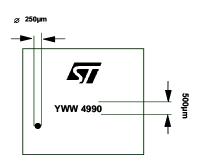


PIN OUT (top view)



■ Balls are underneath

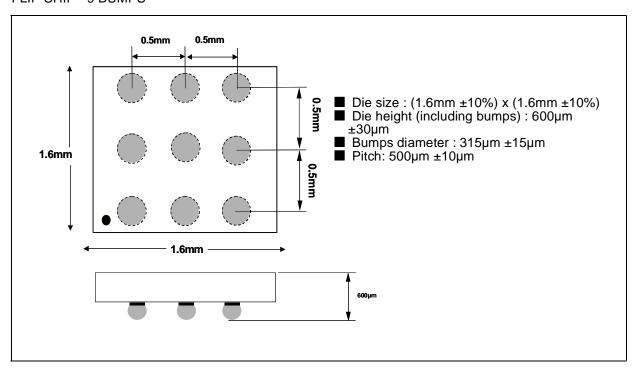
MARKING (top view)



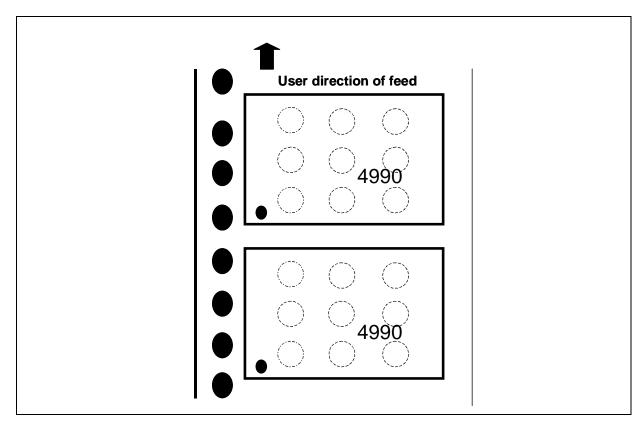
- ST Logo Part number_4990
- Three digits Datecode: YWW ■ The dot is for marking pin 1

PACKAGE MECHANICAL DATA

FLIP CHIP - 9 BUMPS



TAPE & REEL SPECIFICATION (top view)



DEVICES ORIENTATION

The devices are oriented in the carrier pocket with pin number 1A adjacent to the sprocket holes.

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